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April 1<sup>st</sup>, 2010 Renesas Electronics Corporation

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# MOS FIELD EFFECT TRANSISTOR 2SJ621

# P-CHANNEL MOS FIELD EFFECT TRANSISTOR FOR SWITCHING

#### **DESCRIPTION**

The 2SJ621 is a switching device which can be driven directly by a 1.8 V power source.

This device features a low on-state resistance and excellent switching characteristics, and is suitable for applications such as power switch of portable machine and so on.

#### **FEATURES**

- 1.8 V drive available
- Low on-state resistance

 $R_{DS(on)1}=44~m\Omega$  MAX. (Vgs =  $-4.5~V,~I_D=-2.0~A)$ 

 $R_{DS(on)2} = 56 \text{ m}\Omega$  MAX. (Vgs = -3.0 V, ID = -2.0 A)

RDS(on)3 = 62 m $\Omega$  MAX. (VGS = -2.5 V, ID = -2.0 A)

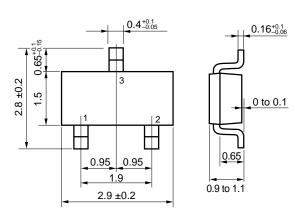
 $R_{DS(on)4} = 105 \text{ m}\Omega \text{ MAX.} \text{ (Vgs} = -1.8 \text{ V, Ip} = -1.5 \text{ A)}$ 

#### **ORDERING INFORMATION**

PART NUMBER	PACKAGE
2SJ621	SC-96 (Mini Mold Thin Type)

Marking: XG

#### PACKAGE DRAWING (Unit: mm)

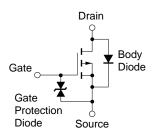


- 1 : Gate 2 : Source
- 3 : Drain

#### ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (Vgs = 0 V)	VDSS	-12	V
Gate to Source Voltage (Vps = 0 V)	Vgss	∓8.0	V
Drain Current (DC) (T <sub>A</sub> = 25°C)	$I_{D(DC)}$	∓3.5	Α
Drain Current (pulse) Note1	ID(pulse)	∓12	Α
Total Power Dissipation (T <sub>A</sub> = 25°C)	P <sub>T1</sub>	0.2	W
Total Power Dissipation (T <sub>A</sub> = 25°C) Note2	$P_{T2}$	1.25	W
Channel Temperature	$T_ch$	150	°C
Storage Temperature	T <sub>stg</sub>	-55 to +150	°C

#### **EQUIVALENT CIRCUIT**



- **Notes 1.** PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1%
  - **2.** Mounted on FR-4 board,  $t \le 5$  sec.

**Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

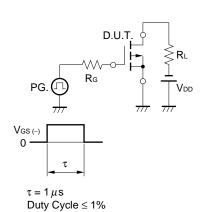
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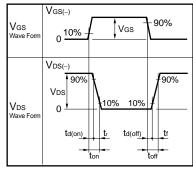


#### **ELECTRICAL CHARACTERISTICS (TA = 25°C)**

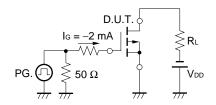
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	Ipss	V <sub>DS</sub> = -12 V, V <sub>GS</sub> = 0 V			-10	μΑ
Gate Leakage Current	lgss	V <sub>GS</sub> = ∓8.0 V, V <sub>DS</sub> = 0 V			∓10	μΑ
Gate Cut-off Voltage	V <sub>GS(off)</sub>	$V_{DS} = -10 \text{ V}, I_{D} = -1.0 \text{ mA}$	0.45		1.5	V
Forward Transfer Admittance	yfs	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -3.5 A	4.0			S
Drain to Source On-state Resistance	RDS(on)1	Vgs = -4.5 V, ID = -2.0 A		35	44	mΩ
	R <sub>DS(on)2</sub>	Vgs = -3.0 V, Ib = -2.0 A		42	56	mΩ
	RDS(on)3	Vgs = -2.5 V, Ib = -2.0 A		46	62	mΩ
	R <sub>DS(on)4</sub>	V <sub>GS</sub> = -1.8 V, I <sub>D</sub> = -1.5 A		63	105	mΩ
Input Capacitance	Ciss	V <sub>DS</sub> = -10 V		630		pF
Output Capacitance	Coss	V <sub>GS</sub> = 0 V		170		pF
Reverse Transfer Capacitance	Crss	f = 1.0 MHz		100		pF
Turn-on Delay Time	td(on)	V <sub>DD</sub> = -6.0 V, I <sub>D</sub> = -2.0 A		20		ns
Rise Time	tr	Vgs = -4.0 V		70		ns
Turn-off Delay Time	td(off)	R <sub>G</sub> = 10 Ω		320		ns
Fall Time	tf			200		ns
Total Gate Charge	Q <sub>G</sub>	V <sub>DD</sub> = -10 V		6.2		nC
Gate to Source Charge	Qgs	V <sub>GS</sub> = -4.0 V		1.0		nC
Gate to Drain Charge	Q <sub>GD</sub>	ID = -3.5 A		2.0		nC
Body Diode Forward Voltage	VF(S-D)	IF = 3.5 A, VGS = 0 V		0.84		V

#### **TEST CIRCUIT 1 SWITCHING TIME**



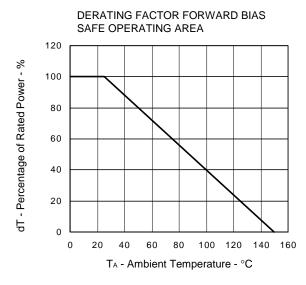


#### **TEST CIRCUIT 2 GATE CHARGE**

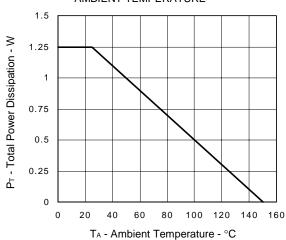




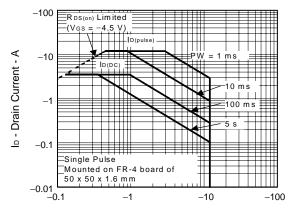
#### TYPICAL CHARACTERISTICS (TA = 25°C)



#### TOTAL POWER DISSIPATION vs. AMBIENT TEMPERATURE

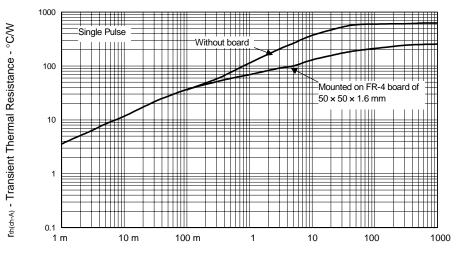


#### FORWARD BIAS SAFE OPERATING AREA



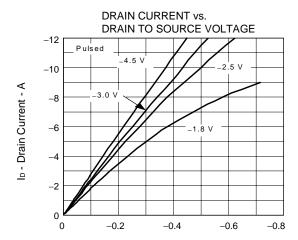
V<sub>DS</sub> - Drain to Source Voltage - V

#### TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

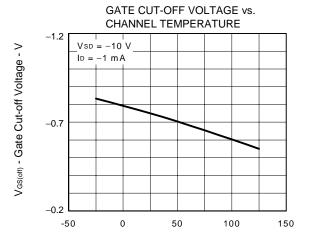


PW - Pulse Width - s

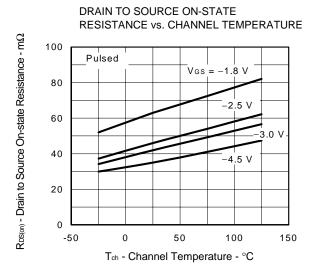
Data Sheet D15634EJ1V0DS 3



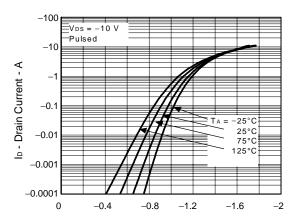
V<sub>DS</sub> - Drain to Source Voltage - V



Tch - Channel Temperature - °C

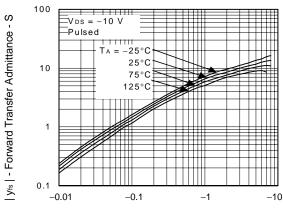


#### FORWARD TRANSFER CHARACTERISTICS



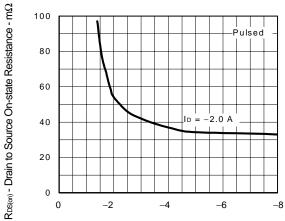
V<sub>GS</sub> - Gate to Source Voltage - V

# FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



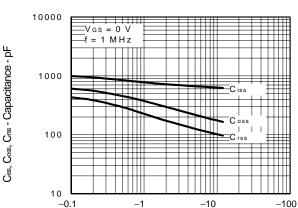
ID - Drain Current - A

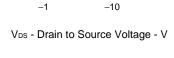
# DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

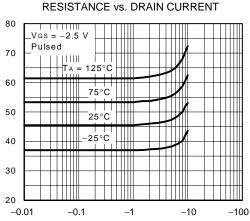


V<sub>GS</sub> - Gate to Source Voltage - V

#### DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT RDS(m) - Drain to Source On-state Resistance - m\Omega R<sub>DS(m)</sub> - Drain to Source On-state Resistance - mΩ 120 Vgs = -1.8 V Pulsed 100 TA = 125°C 80 75°C 25°C 60 -25°C 40 -0.01-0.1 -10 -100 ID - Drain Current - A DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT RDS(m) - Drain to Source On-state Resistance - mΩ $\mathsf{R}_{\mathsf{DS}(m)}$ - Drain to Source On-state Resistance - m $\Omega$ 80 -Vgs = -3.0 VPulsed 70 60 TA = 125°C 75°C 50 -25°C 40 -25°C 30 20 -0.01-0.1 -10 -100ID - Drain Current - A CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE



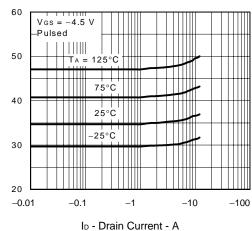




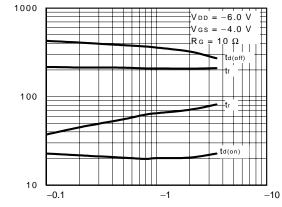
DRAIN TO SOURCE ON-STATE

I<sub>D</sub> - Drain Current - A

#### DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



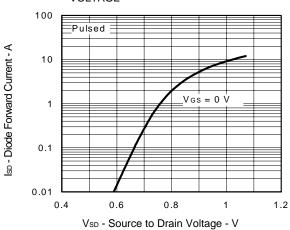
SWITCHING CHARACTERISTICS



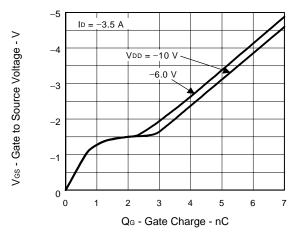
ID - Drain Current - A

ta(on), tr, ta(off), tr - Switching Time - ns

# SOURCE TO DRAIN DIODE FORWARD VOLTAGE



#### DYNAMIC INPUT/OUTPUT CHARACTERISTICS



2SJ621



[MEMO]

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